2021 EDITORIAL CALENDAR

Issue	Featured and New Product Coverage	Important Industry Events
January	Antennas, Cable Assemblies, Couplers, Test and Measurement	IEuMW Utrecht, Netherlands, Jan 10 - 15 IEEE Radio & Wireless Week Santa Clara, San Diego, Jan 17 – 20
February	Design Tools, Power Amplifiers Filters, Mil-Aero Products	Satellite Washington, DC, March 16 - 18
March	Passive Components- Attenuators, DC Blocks/Bias Tees	WAMICON Clearwater Beach, April TBD DesignCon San Jose, Apr 13 – 15
April	Test & Measurement Tools Cable Assemblies, Integrated Assemblies	IEEE EMC + SIPI Raleigh, NC, May 3 - 7
May	Active Components, Switches, Mixers, Phase Shifters, IMS2020 Show Issue	IMS Atlanta, June 6 – 11
June	Frequency Control Components, Low Loss Cables, Design Tools Update	
July	Passive Components, Isolators, Circulators, Connectors, Antennas	IEEE Autotestcon National Harbor, MD, Aug 30 - Sept 2
August	Defense Electronics EDA, Automated Test, Test Cables, Signal Generators	
September	Millimeter Connectors and Components, Detectors	NAB Las Vegas, Oct 9 – 13 MILCOM, location TBD, October
October	Circuit Materials, Interconnects, Base Station Products, Network Analyzers, Mil-Spec Products	
November	Coaxial Adapters, Low Noise Amplifiers, Modular Test Equipment	AOC International Washington DC, Nov 30
December	Passive Components, Couplers and Power Dividers, Crystal Oscillators, VCOs, YIG Oscillators	IEEE Radio & Wireless Symposium, location TBD, January 2022

Additional technical articles can be published in each issue, covering other topics **AD CLOSING DATES:** 15th of the prior month (next business day if weekend) **AD MATERIAL DEADLINE:** 20th of the prior month. Contact your advertising sales representative for extra time or special requirements **BONUS DISTRIBUTIONS:** Subject to change.

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Editorial Submissions

Regular Columns

Meetings & Events, In the News, Design Notes, High Frequency Applications

Press Releases

Press releases for our informational columns should be sent by the first of the month prior to the desired publication date (e.g., April 1 for the May issue). Latebreaking news can be accommodated, but please advise the editors of urgent items by telephone or e-mail.

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Article Contributions

We encourage the submission of technical articles, application notes and other editorial contributions. These may be on the topics noted above, or any other subject of current interest. Contact us with article ideas:

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